



## UCx52xA Regulating Pulse Width Modulators

### 1 Features

- 8-V to 35-V Operation
- 5.1-V Reference Trimmed to 1%
- 100-Hz to 500-kHz Oscillator Range
- Separate Oscillator Sync Terminal
- Adjustable Dead-Time Control
- Internal Soft Start
- Pulse-by-Pulse Shutdown
- Input Undervoltage Lockout With Hysteresis
- Latching PWM to Prevent Multiple Pulses
- Dual Source and Sink Output Drivers

### 2 Applications

- Off-Line and DC/DC Power Supplies
- Converters Using Voltage Mode
- Single-Ended or Two-Switch Topology Designs
- Solar Inverters
- Welding Inverters
- Motor Control
- Battery Chargers

### 3 Description

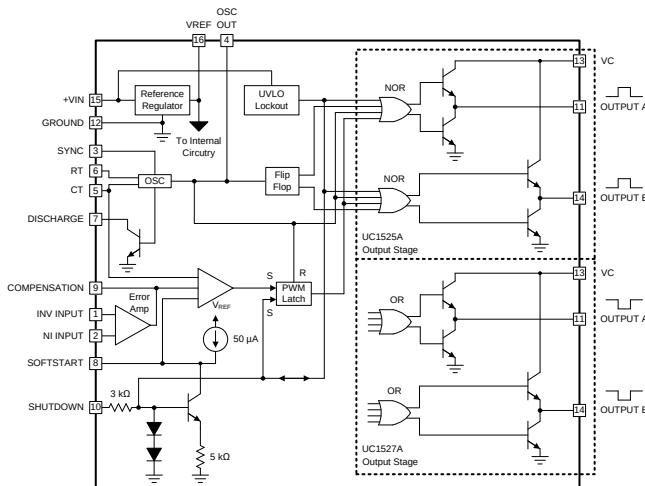
The UC1525A/1527A series of pulse width modulator integrated circuits are designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The on-chip 5.1-V reference is trimmed to 1% and the input common-mode range of the error amplifier includes the reference voltage, eliminating external resistors. A sync input to the oscillator allows multiple units to be slaved or a single unit to be synchronized to an external system clock. A single resistor between  $C_T$  and the discharge terminals provides a wide range of dead-time adjustment. These devices also feature built-in soft-start circuitry with only an external timing capacitor required. A shutdown terminal controls both the soft-start circuitry and the output stages, providing instantaneous turn off through the PWM latch with pulsed shutdown, as well as soft-start recycle with longer shutdown commands.

#### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE   | BODY SIZE (NOM)    |
|-------------|-----------|--------------------|
| UCx52xA     | LCCC (20) | 8.89 mm × 8.89 mm  |
|             | CDIP (16) | 19.56 mm × 6.67 mm |
|             | SOIC (16) | 10.30 mm × 7.50 mm |
|             | PDIP (16) | 19.30 mm × 6.35 mm |
|             | PLCC (20) | 8.96 mm × 8.96 mm  |

(1) For all available packages, see the orderable addendum at the end of the data sheet.

**Block Diagram**



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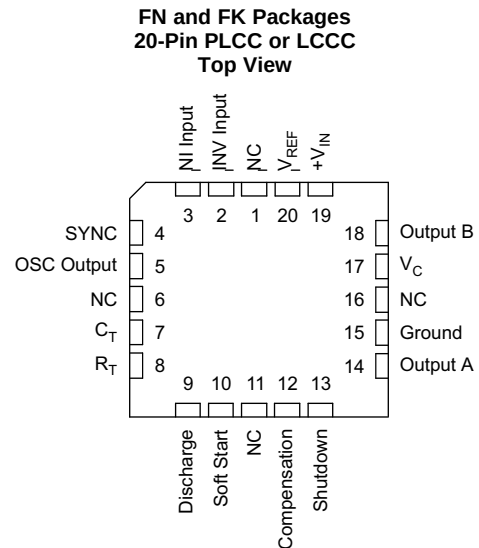
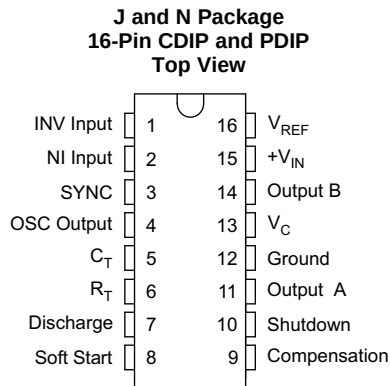
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## 4 Revision History

| Changes from Revision C (January 2008) to Revision D                                                                                                                                                                                                                                        | Page |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section ..... | 1    |
| • Added Thermal Information table .....                                                                                                                                                                                                                                                     | 5    |
| • Changed $R_{\theta JA}$ values in the Thermal Information table: from 80-120 to N/A for J; from 90 to 47.6 for N; from 45-90 to 72.6 for DW; from 43-75 to 55.8 for FN; and from 70-80 to N/A for FK .....                                                                                | 5    |
| • Changed $R_{\theta JC}$ values in the Thermal Information table: from 28 to 37.4 (top) and 10.1 (bottom) for J; from 45 to 37.3 (top) for N; from 25 to 34 (top) for DW; from 34 to 33.7 (top) for FN; and from 20 to 32.9 (top) to 3.5 (bottom) for FK .....                             | 5    |

## 5 Pin Configuration and Functions



### Pin Functions

| PIN          |            |              | I/O | DESCRIPTION                                                                                                                                                       |
|--------------|------------|--------------|-----|-------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| NAME         | CDIP, PDIP | PLCC, LCCC   |     |                                                                                                                                                                   |
| INV Input    | 1          | 2            | I   | Inverting input to the error amplifier                                                                                                                            |
| NI Input     | 2          | 3            | I   | Noninverting input to the error amplifier                                                                                                                         |
| SYNC         | 3          | 4            | I   | Oscillator sync terminal                                                                                                                                          |
| OSC Output   | 4          | 5            | O   | Oscillator frequency output                                                                                                                                       |
| CT           | 5          | 7            | I   | Timing capacitor connection pin for oscillator frequency programming. The timing capacitor should be connected to the device ground using minimal trace length.   |
| RT           | 6          | 8            | I   | Timing resistor connection pin for oscillator frequency programming                                                                                               |
| Discharge    | 7          | 9            | I   | A single resistor between CT and the discharge terminals provides dead-time adjustment                                                                            |
| Soft Start   | 8          | 10           | I   | Soft-start input pin.                                                                                                                                             |
| Compensation | 9          | 12           | O   | Output of the error amplifier for compensation                                                                                                                    |
| Shutdown     | 10         | 13           | I   | Pull this pin high to shut down PWM output                                                                                                                        |
| Output A     | 11         | 14           | O   | output A of the on-chip drive stage                                                                                                                               |
| Ground       | 12         | 15           | —   | Ground return pin                                                                                                                                                 |
| VC           | 13         | 17           | —   | Power supply pin for the output stage. This pin should be bypassed with a 0.1-μF monolithic ceramic low ESL capacitor with minimal trace lengths.                 |
| Output B     | 14         | 18           | O   | Output B of the on-chip drive stage.                                                                                                                              |
| +VIN         | 15         | 19           | —   | Input voltage                                                                                                                                                     |
| VREF         | 16         | 20           | O   | 5.1-V reference. For stability, the reference should be bypassed with a 0.1-μF monolithic ceramic low ESL capacitor and minimal trace length to the ground plane. |
| NC           | —          | 1, 6, 11, 16 | —   | No internal connection                                                                                                                                            |

## 6 Specifications

### 6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)<sup>(1)</sup>

|                  |                                                | MIN  | MAX              | UNIT |
|------------------|------------------------------------------------|------|------------------|------|
| +V <sub>IN</sub> | Supply voltage                                 |      | 40               | V    |
| V <sub>C</sub>   | Collector supply voltage                       |      | 40               | V    |
|                  | Logic inputs                                   | –0.3 | 5.5              | V    |
|                  | Analog inputs                                  | –0.3 | +V <sub>IN</sub> | V    |
|                  | Output current, source or sink                 |      | 500              | mA   |
|                  | Reference output current                       |      | 50               | mA   |
|                  | Oscillator charging current                    |      | 5                | mA   |
|                  | Power dissipation at T <sub>A</sub> = +25°C(2) |      | 1000             | mW   |
|                  | Power dissipation at T <sub>C</sub> = +25°C(2) |      | 2000             | mW   |
|                  | Operating junction temperature                 | –55  | 150              | °C   |
|                  | Lead temperature (soldering, 10 seconds)       |      | 300              | °C   |
| T <sub>stg</sub> | Storage temperature                            | –65  | 150              | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|                    |                         | VALUE                                                                          | UNIT |
|--------------------|-------------------------|--------------------------------------------------------------------------------|------|
| V <sub>(ESD)</sub> | Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | 3000 |
|                    |                         | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | 1500 |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

|                               |                                         | MIN   | MAX  | UNIT |
|-------------------------------|-----------------------------------------|-------|------|------|
| +V <sub>IN</sub>              | Input voltage                           | 8     | 35   | V    |
| V <sub>C</sub>                | Collector supply voltage                | 4.5   | 35   | V    |
|                               | Sink/source load current (steady state) | 0     | 100  | mA   |
|                               | Sink/source load current (peak)         | 0     | 400  | mA   |
|                               | Reference load current                  | 0     | 20   | mA   |
|                               | Oscillator frequency range              | 100   | 400  | Hz   |
|                               | Oscillator timing resistor              | 2     | 150  | kΩ   |
|                               | Oscillator timing capacitor             | 0.001 | 0.01 | μF   |
|                               | Dead time resistor range                | 0     | 500  | Ω    |
| Operating ambient temperature | UC1525A, UC1527A                        | –55   | 125  | °C   |
|                               | UC2525A, UC2527A                        | –25   | 85   |      |
|                               | UC3525A, UC3527A                        | 0     | 70   |      |

## 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup> |                                              | UCx52xA      |             |              |             |              | UNIT |
|-------------------------------|----------------------------------------------|--------------|-------------|--------------|-------------|--------------|------|
|                               |                                              | FK<br>(LCCC) | J<br>(CDIP) | DW<br>(SOIC) | N<br>(PDIP) | FN<br>(PLCC) |      |
|                               |                                              | 20 PINS      | 16 PINS     | 16 PINS      | 16 PINS     | 20 PINS      |      |
| R <sub>θJA</sub>              | Junction-to-ambient thermal resistance       | N/A          | N/A         | 72.6         | 47.6        | 55.8         | °C/W |
| R <sub>θJC(top)</sub>         | Junction-to-case (top) thermal resistance    | 32.9         | 37.4        | 34           | 37.3        | 33.7         | °C/W |
| R <sub>θJB</sub>              | Junction-to-board thermal resistance         | 32.1         | 54.2        | 37.3         | 27.7        | 21.1         | °C/W |
| Ψ <sub>JT</sub>               | Junction-to-top characterization parameter   | N/A          | N/A         | 8.9          | 17.3        | 9.7          | °C/W |
| Ψ <sub>JB</sub>               | Junction-to-board characterization parameter | N/A          | N/A         | 36.8         | 27.5        | 20.8         | °C/W |
| R <sub>θJC(bot)</sub>         | Junction-to-case (bottom) thermal resistance | 3.5          | 10.1        | N/A          | N/A         | N/A          | °C/W |

(1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                         | TEST CONDITIONS                                  |                     | MIN  | TYP  | MAX  | UNIT  |
|---------------------------------------------------|--------------------------------------------------|---------------------|------|------|------|-------|
| REFERENCE                                         |                                                  |                     |      |      |      |       |
| Output voltage                                    | T <sub>J</sub> = 25°C                            | UC152xA,<br>UC252xA | 5.05 | 5.1  | 5.15 | V     |
|                                                   |                                                  | UC352xA             | 5    | 5.1  | 5.2  |       |
| Line regulation                                   | V <sub>IN</sub> = 8 V to 35 V                    |                     |      | 10   | 20   | mV    |
| Load regulation                                   | I <sub>L</sub> = 0 mA to 20 mA                   |                     |      | 20   | 50   | mV    |
| Temperature stability <sup>(1)</sup>              | Over operating                                   |                     |      | 20   | 50   | mV    |
| Total output variation <sup>(1)</sup>             | Line, load, and temperature                      | UC152xA,<br>UC252xA | 5    |      | 5.2  | V     |
|                                                   |                                                  | UC352xA             | 4.95 |      | 5.25 |       |
| Shorter circuit current                           | V <sub>REF</sub> = 0, T <sub>J</sub> = 25°C      |                     |      | 80   | 100  | mA    |
| Output noise Voltage <sup>(1)</sup>               | 10 Hz ≤ 10 kHz, T <sub>J</sub> = 25°C            |                     |      | 40   | 200  | μVrms |
| Long-term stability <sup>(1)</sup>                | T <sub>J</sub> = 125°C                           |                     |      | 20   | 50   | mV    |
| OSCILLATOR SECTION <sup>(2)</sup>                 |                                                  |                     |      |      |      |       |
| Initial accuracy <sup>(1)(2)</sup>                | T <sub>J</sub> = 25°C                            |                     |      | 2%   | 6%   |       |
| Voltage stability <sup>(1)(2)</sup>               | V <sub>IN</sub> = 8 V to 35 V                    | UC152xA,<br>UC252xA |      | 0.3% | 1%   |       |
|                                                   |                                                  | UC352xA             |      | 1%   | 2%   |       |
| Temperature stability <sup>(1)</sup>              | Over operating                                   |                     |      | 3%   | 6%   |       |
| Minimum frequency                                 | R <sub>T</sub> = 200 kΩ, C <sub>T</sub> = 0.1 mF |                     |      |      | 120  | Hz    |
| Maximum frequency                                 | R <sub>T</sub> = 2 kΩ, C <sub>T</sub> = 470 pF   |                     | 400  |      |      | kHz   |
| Current mirror                                    | I <sub>RT</sub> = 2 mA                           |                     | 1.7  | 2    | 2.2  | mA    |
| Clock amplitude <sup>(1)(2)</sup>                 |                                                  |                     | 3    | 3.5  |      | V     |
| Clock width <sup>(1)(2)</sup>                     | T <sub>J</sub> = 25°C                            |                     | 0.3  | 0.5  | 1    | μs    |
| Synconization threshold <sup>(1)(2)</sup>         |                                                  |                     | 1.2  | 2    | 2.8  | V     |
| Sync input current                                | Sync voltage = 3.5 V                             |                     |      | 1    | 2.5  | mA    |
| ERROR AMPLIFIER SECTION (V <sub>CM</sub> = 5.1 V) |                                                  |                     |      |      |      |       |
| Input offset voltage                              | UC152xA, UC252xA                                 |                     |      | 0.5  | 5    | mV    |
|                                                   | UC352xA                                          |                     |      | 2    | 10   |       |

(1) These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

(2) Tested at f<sub>OSC</sub> = 40 kHz (R<sub>T</sub> = 3.6 kΩ, C<sub>T</sub> = 0.01 mF, R<sub>D</sub> = 0. Approximate oscillator frequency is defined by

$$f = \frac{1}{C_T (0.7R_T + 3R_D)}$$

## Electrical Characteristics (continued)

over operating free-air temperature range (unless otherwise noted)

| PARAMETER                                            | TEST CONDITIONS                                            | MIN | TYP  | MAX | UNIT |
|------------------------------------------------------|------------------------------------------------------------|-----|------|-----|------|
| Input bias current                                   |                                                            |     | 1    | 10  | μA   |
| Input offset current                                 |                                                            |     |      | 1   |      |
| DC open loop gain                                    | R <sub>L</sub> ≥ 10 MΩ                                     | 60  | 75   |     | dB   |
| Gain-bandwidth product <sup>(1)</sup>                | A <sub>V</sub> = 0 dB, T <sub>J</sub> = 25°C               | 1   | 2    |     | MHz  |
| DC transconductance <sup>(1)(3)</sup>                | T <sub>J</sub> = 25°C, 30 kΩ ≤ R <sub>L</sub> ≤ 1 MΩ       | 1.1 | 1.5  |     | mS   |
| Low-level output voltage                             |                                                            |     | 0.2  | 0.5 | V    |
| High-level output voltage                            |                                                            | 3.8 | 5.6  |     |      |
| Common mode rejection                                | V <sub>CM</sub> = 1.5 V to 5.2 V                           | 60  | 75   |     | dB   |
| Supply voltage rejection                             | V <sub>IN</sub> = 8 V to 35 V                              | 50  | 60   |     |      |
| PWM COMPARATOR                                       |                                                            |     |      |     |      |
| Minimum duty-cycle                                   |                                                            |     |      | 0%  |      |
| Maximum duty-cycle                                   |                                                            | 45% | 49%  |     |      |
| Input threshold <sup>(4)</sup>                       | Zero duty-cycle                                            | 0.7 | 0.9  |     | V    |
|                                                      | Maximum duty-cycle                                         |     | 3.3  | 3.6 |      |
| Input bias current <sup>(4)</sup>                    |                                                            |     | 0.05 | 1   | μA   |
| SHUTDOWN                                             |                                                            |     |      |     |      |
| Soft-start current                                   | V <sub>SD</sub> = 0 V, V <sub>SS</sub> = 0 V               | 25  | 50   | 80  | μA   |
| Soft-start low level                                 | V <sub>SD</sub> = 2.5 V                                    |     | 0.4  | 0.7 | V    |
| Shutdown threshold                                   | To outputs, V <sub>SS</sub> = 5.1 V, T <sub>J</sub> = 25°C | 0.6 | 0.8  | 1   |      |
| Shutdown input current                               | V <sub>SD</sub> = 2.5 V                                    |     | 0.4  | 1   | mA   |
| Shutdown Delay <sup>(5)</sup>                        | V <sub>SD</sub> = 2.5 V, T <sub>J</sub> = 25°C             |     | 0.2  | 0.5 | μS   |
| OUTPUT DRIVERS (EACH OUTPUT) (V <sub>C</sub> = 20 V) |                                                            |     |      |     |      |
| Low-level output voltage                             | I <sub>SINK</sub> = 20 mA                                  |     | 0.2  | 0.4 | V    |
|                                                      | I <sub>SINK</sub> = 100 mA                                 |     | 1    | 2   |      |
| High-level output voltage                            | I <sub>SOURCE</sub> = 20 mA                                | 18  | 19   |     | V    |
|                                                      | I <sub>SOURCE</sub> = 100 mA                               | 17  | 18   |     |      |
| Undervoltage lockout                                 | V <sub>COMP</sub> and V <sub>SS</sub> = High               | 6   | 7    | 8   | V    |
| V <sub>C</sub> OFF current <sup>(6)</sup>            | V <sub>C</sub> = 35 V                                      |     |      | 200 | μA   |
| Rise time <sup>(5)</sup>                             | C <sub>L</sub> = 1 nF, T <sub>J</sub> = 25°C               |     | 100  | 600 | ns   |
| Fall time <sup>(5)</sup>                             | C <sub>L</sub> = 1 nF, T <sub>J</sub> = 25°C               |     | 50   | 300 |      |
| TOTAL STANDBY CURRENT                                |                                                            |     |      |     |      |
| Supply current                                       | V <sub>IN</sub> = 35 V                                     |     | 14   | 20  | mA   |

(3) DC transconductance ( $g_M$ ) relates to DC open-loop voltage gain ( $A_V$ ) according to the following equation:  $A_V = g_M R_L$  where  $R_L$  is the resistance from pin 9 to ground. The minimum  $g_M$  specification is used to calculate minimum  $A_V$  when the error amplifier output is loaded.

(4) Tested at  $f_{OSC} = 40 \text{ kHz}$  ( $R_T = 3.6 \text{ k}\Omega$ ,  $C_T = 0.01 \text{ mF}$ ,  $R_D = 0 \Omega$ ).

(5) These parameters, although ensured over the recommended operating conditions, are not 100% tested in production.

(6) Collector off-state quiescent current measured at pin 13 with outputs low for UC1525A and high for UC1527A.

## 6.6 Typical Characteristics

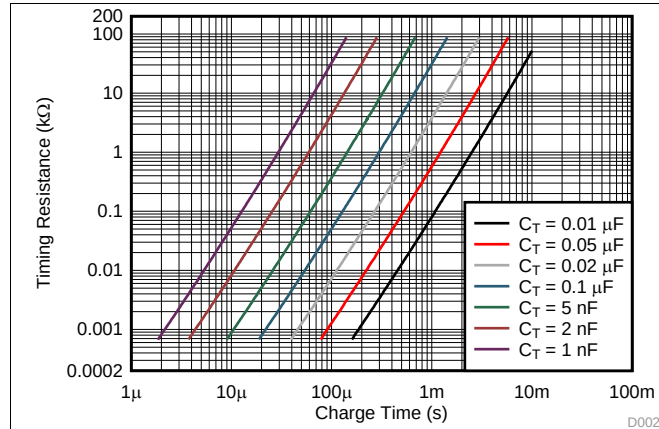


Figure 1. Oscillator Charge Time vs  $R_T$  and  $C_T$

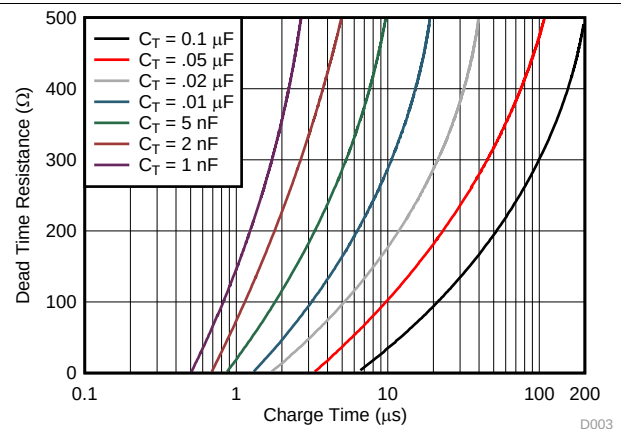


Figure 2. Oscillator Discharge Time vs  $R_T$   $C_T$

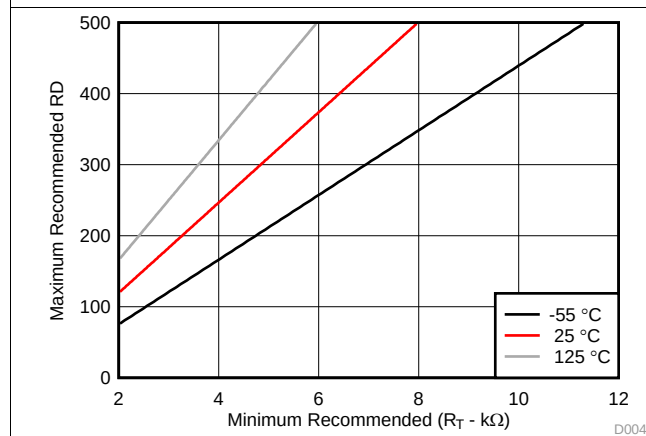


Figure 3. Maximum Value  $R_D$  vs Minimum Value  $R_T$

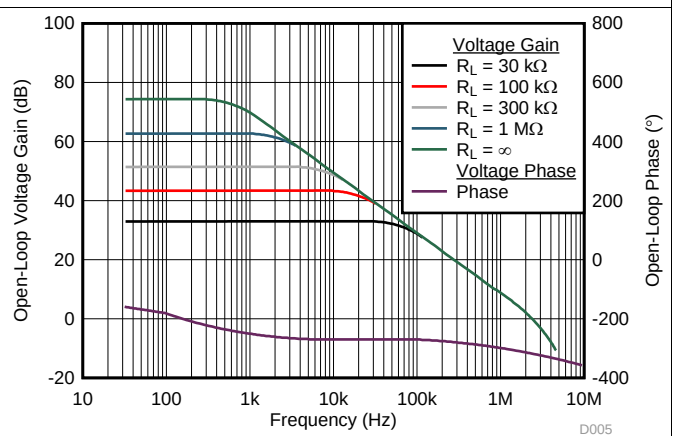


Figure 4. Error Amplifier Voltage Gain and Phase vs Frequency

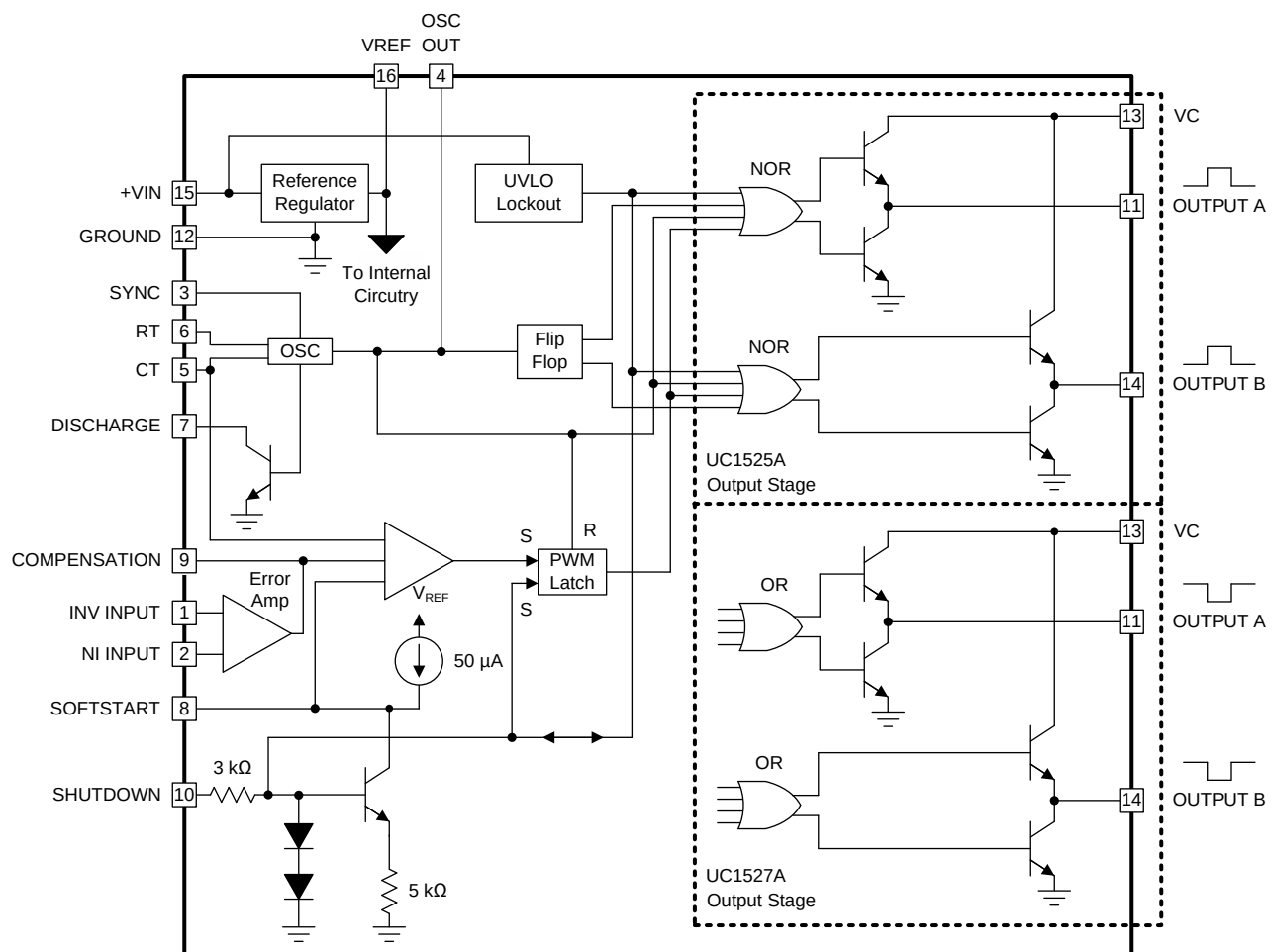
## 7 Detailed Description

### 7.1 Overview

The UCx52xA series of pulse width modulator integrated circuits are designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The on-chip 5.1-V reference is trimmed to 1% and the input common-mode range of the error amplifier includes the reference voltage, eliminating external resistors. A sync input to the oscillator allows multiple units to be slaved or a single unit to be synchronized to an external system clock. A single resistor between CT and the discharge terminals provides a wide range of dead-time adjustment. These devices also feature built-in soft-start circuitry with only an external timing capacitor required. A shutdown terminal controls both the soft-start circuitry and the output stages, providing instantaneous turn off through the PWM latch with pulsed shutdown, as well as soft-start recycle with longer shutdown commands.

These functions are also controlled by an undervoltage lockout which keeps the outputs off and the soft-start capacitor discharged for subnormal input voltages. This lockout circuitry includes approximately 500 mV of hysteresis for jitter-free operation. Another feature of these PWM circuits is a latch following the comparator. Once a PWM pulse has been terminated for any reason, the outputs will remain off for the duration of the period. The latch is reset with each clock pulse. The output stages are totem-pole designs capable of sourcing or sinking in excess of 200 mA. The UC1525A output stage features NOR logic, giving a LOW output for an OFF state. The UC1527A uses OR logic, which results in a HIGH output level when OFF.

### 7.2 Functional Block Diagram



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## 7.3 Feature Description

### 7.3.1 Adjustable Dead-Time Control

A single resistor between CT and the discharge terminals provides a wide range of dead-time adjustment.

### 7.3.2 Soft Start

Soft start is achieved by connecting the soft-start pin to ground through a capacitor, charged by the 50- $\mu$ A current source. See [Functional Block Diagram](#).

### 7.3.3 Input Undervoltage Lockout With Hysteresis

The undervoltage lockout keeps the outputs off and the soft-start capacitor discharged for subnormal input voltages. This lockout circuitry includes approximately 500 mV of hysteresis for jitter-free operation.

### 7.3.4 Shutdown and Pulse-by-Pulse Current Limiting

See [Shutdown Options \(See Functional Block Diagram\)](#).

## 7.4 Device Functional Modes

This device has no functional modes.

### 7.4.1 Shutdown Options (See [Functional Block Diagram](#))

Since both the compensation and soft-start terminals have current source pullups, either can readily accept a pull-down signal which only has to sink a maximum of 100 A to turn off the outputs. This is subject to the added requirement of discharging whatever external capacitance may be attached to these pins.

An alternate approach is the use of the shutdown circuitry of the shutdown pin which has been improved to enhance the available shutdown options. Activating this circuit by applying a positive signal on the shutdown pin performs two functions; the PWM latch is immediately set providing the fastest turn-off signal to the outputs; and a 150-A current sink begins to discharge the external soft-start capacitor. If the shutdown command is short, the PWM signal is terminated without significant discharge of the soft-start capacitor, thus, allowing, for example, a convenient implementation of pulse-by-pulse current limiting. Holding the shutdown pin high for a longer duration, however, will ultimately discharge this external capacitor, recycling slow turnon upon release.

The shutdown pin should not be left floating as noise pickup could conceivably interrupt normal operation. All transitions of the voltage on the shutdown pin should be within the time frame of one clock cycle and not repeated at a frequency higher than 10 clock cycles.

## 8 Application and Implementation

### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

The UC1525A/1527A series of pulse width modulator integrated circuits are designed to offer improved performance and lowered external parts count when used in designing all types of switching power supplies. The UC1525A output stage features NOR logic, giving a LOW output for an OFF state. The UC1527A utilizes OR logic which results in a HIGH output level when OFF.

### 8.2 Typical Application

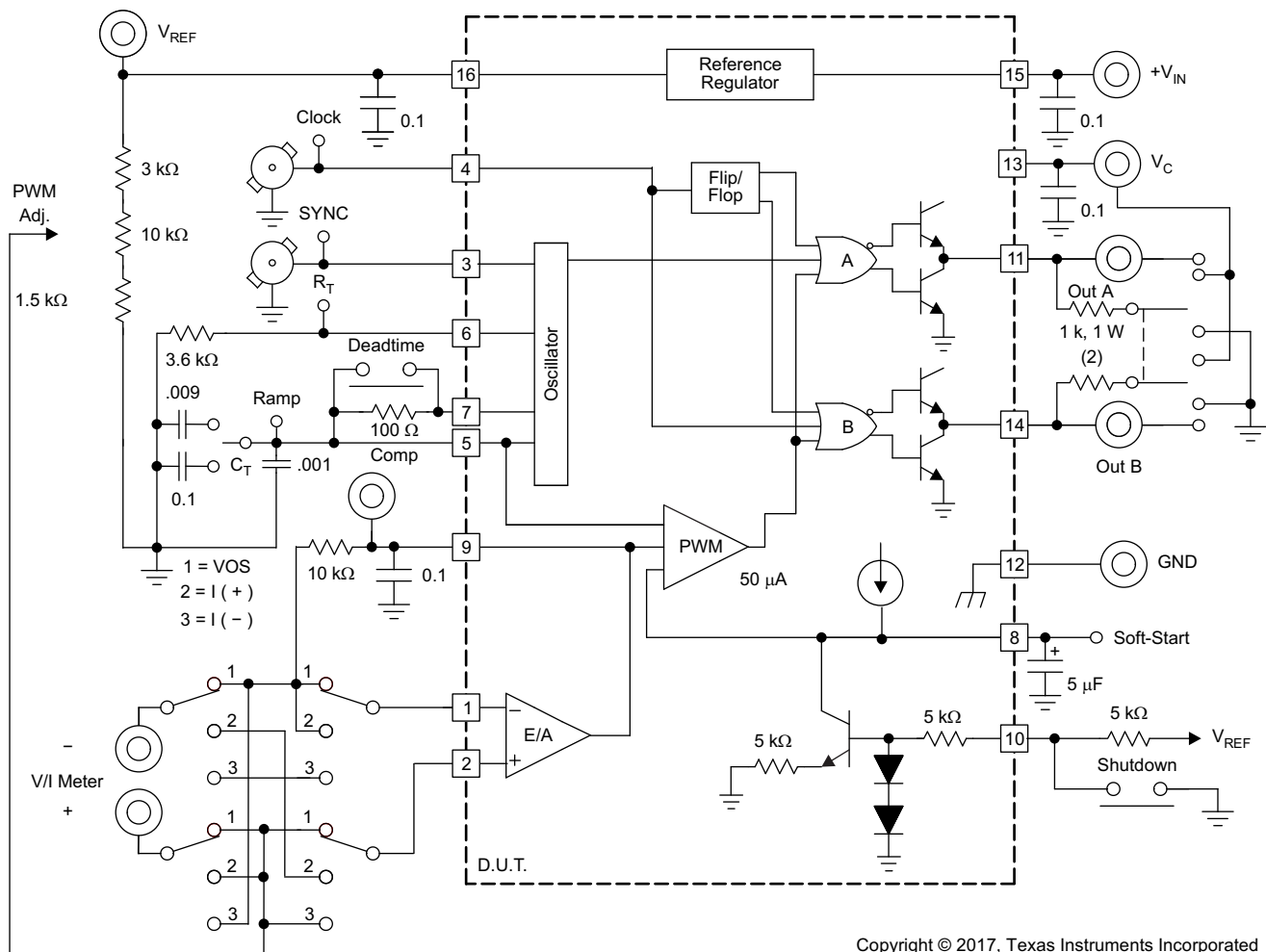
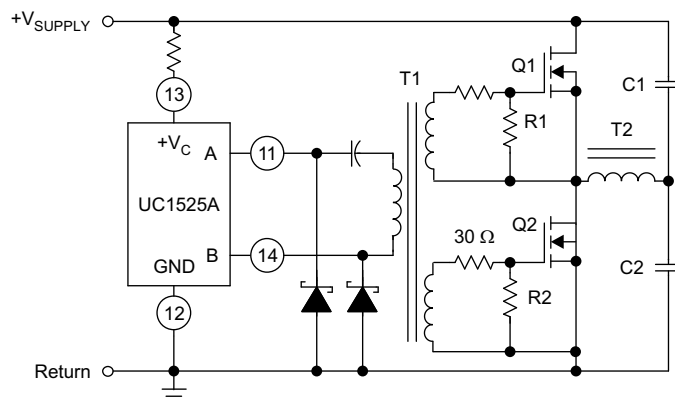


Figure 5. Lab Test Fixture

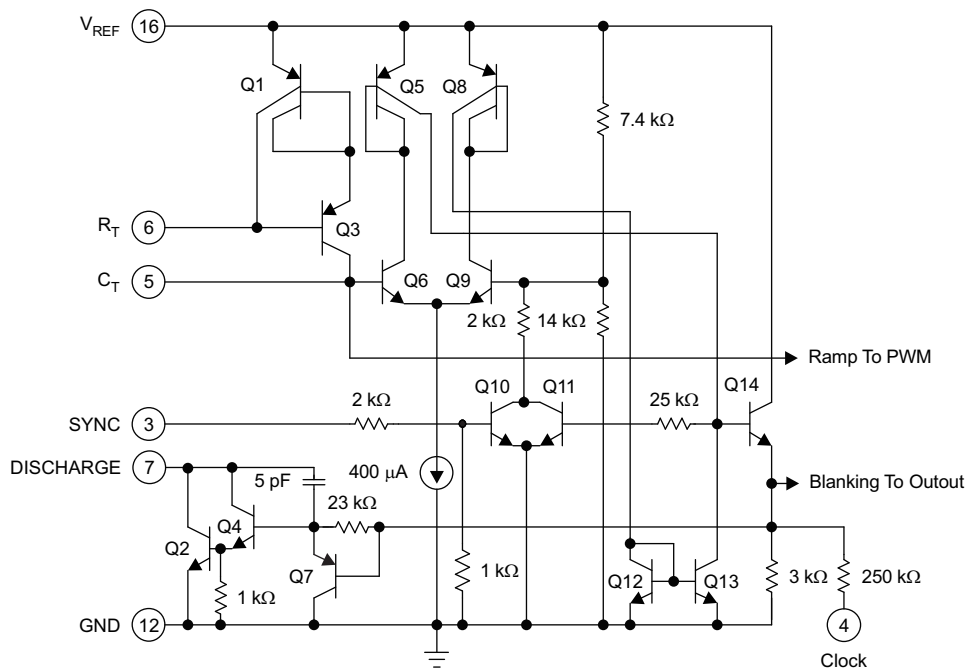
## Typical Application (continued)

### 8.2.1 Theory of Operation



**Figure 6. Low Power Transformers**

Low power transformers can be driven by the UC1525A. Automatic reset occurs during dead time, when both ends of the primary winding are switched to ground.



**Figure 7. UC1525A Oscillator Schematic**

## Typical Application (continued)

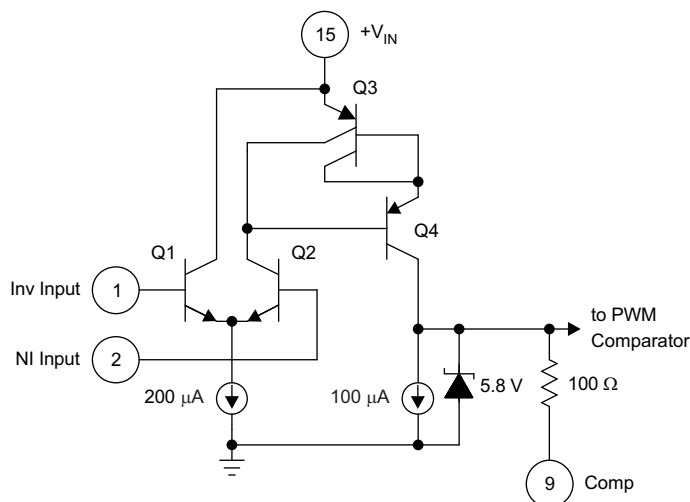


Figure 8. UC1525A Error Amplifier

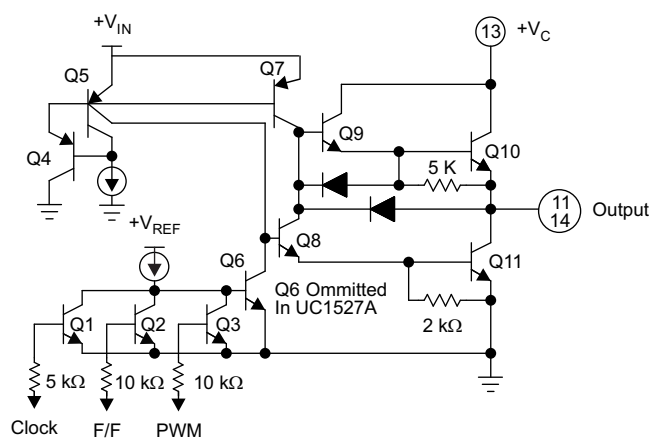


Figure 9. UC1525A Output Circuit (1/2 circuit shown)

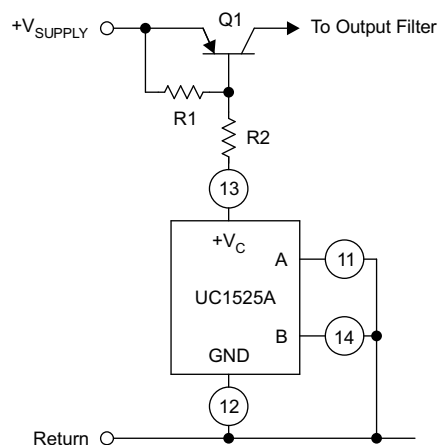
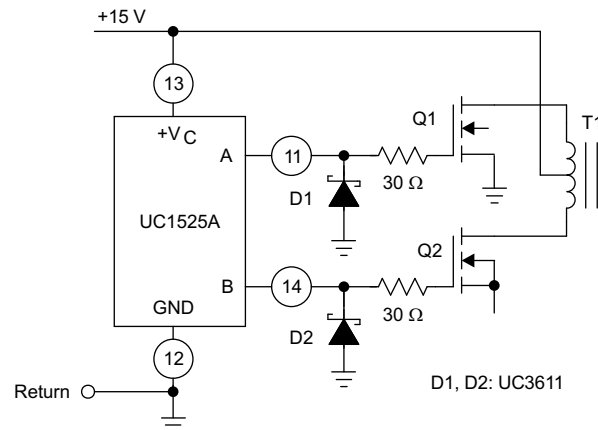


Figure 10. Grounded Driver Outputs For Single-Ended Supplies

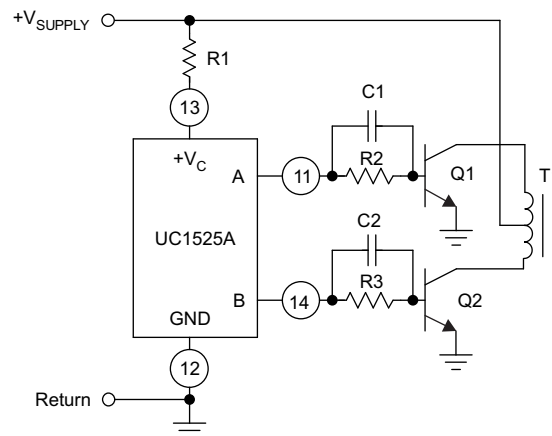
## Typical Application (continued)

For single-ended supplies, the driver outputs are grounded. The  $V_C$  terminal is switched to ground by the totem-pole source transistors on alternate oscillator cycles.



**Figure 11. Output Drivers With Low Source Impedance**

The low source impedance of the output drivers provides rapid charging of power FET input capacitance while minimizing external components.



**Figure 12. Conventional Push-Pull Bipolar Design**

In conventional push-pull bipolar designs, forward base drive is controlled by R1–R3. Rapid turn-off times for the power devices are achieved with speed-up capacitors C1 and C2.

### 8.2.2 Design Requirements

This example illustrates the design process and component selection for a push-pull DC-DC converter utilizing the UC1525A. The converter regulates a 30-V input to a 5-V output with 10-A maximum load.

**Table 1. Design Parameters**

| PARAMETER |                      | MIN | TYP | MAX | UNIT |
|-----------|----------------------|-----|-----|-----|------|
| $V_{IN}$  | Input voltage range  | 25  | 30  | 35  | V    |
| $V_{OUT}$ | Output voltage       |     | 5   |     | V    |
| $i_{OUT}$ | Output current       | 1   |     | 10  | A    |
| $f_O$     | Oscillator frequency |     | 100 |     | kHz  |
| $f_S$     | Switching frequency  |     | 50  |     | kHz  |

## 8.2.3 Detailed Design Procedure

### 8.2.3.1 Timing Resistor and Capacitor Selection

Generally, higher switching frequency gives smaller size but have higher switching loss. Operation at 100 kHz was selected in this example as a reasonable compromise between size and efficiency. The value of  $R_T = 10\text{ k}\Omega$ ,  $C_T = 1.37\text{ nF}$  and  $R_D = 100\text{ }\Omega$  were chosen for 100-kHz oscillator frequency based on equation:

$$f = \frac{1}{C_T(0.7 R_T + 3 R_D)} \quad (1)$$

### 8.2.3.2 Turns Ratio Selection

The maximum primary-to-secondary turns ratio  $N_{MAX}$  can be determined by the target output voltage, minimum input voltage, and the estimated maximum duty cycle.  $D_{LIM} = 0.35$  was selected for this example.  $N_{MAX}$  can be calculated using Equation 1.

$$N_{MAX} = \frac{2 \times D_{LIM} \times V_{IN(min)}}{V_{OUT} + V_F} = \frac{2 \times 0.35 \times 25\text{ V}}{5\text{ V} + 0.3\text{ V}} = 3.3 \quad (2)$$

Rounding  $N_{MAX}$  down to the next lowest integer results in a turns ratio of  $N = 3$ .

### 8.2.3.3 Inductor Selection

The maximum inductor ripple current occurs at the maximum input voltage. Typically, 20% to 40% of the full load current ripple is a good compromise between core loss and copper loss of the inductor. Higher ripple current allows for a smaller inductor size, but places more burden on the output capacitor to smooth the ripple voltage on the output. In this example, a ripple current of 25% of 10 A was chosen. The inductor value can be calculated as:

$$L_O = \frac{V_{OUT} + V_F}{\Delta I_L \times f_{SW}} \times \left( \frac{1}{2} - \frac{N \times (V_{OUT} + V_F)}{2 \times V_{IN(max)}} \right) = 11.57\text{ }\mu\text{H} \quad (3)$$

### 8.2.3.4 Rectification Diode Selection

A rectification diode should always possess low-forward voltage drop. When used in high-frequency switching applications, the diode must also possess a short recovery time. Schottky diodes meet both requirements and are therefore strongly recommended in push-pull converter designs.

### 8.2.3.5 VC Capacitor Selection

The primary purpose of the VC capacitor is to supply the peak transient currents of the drivers as well as provide stability for the VC regulator. These peak currents can be several amperes. The recommended value of VC capacitor should be no smaller than  $0.1\text{ }\mu\text{F}$ , and should be a good quality, low ESR, ceramic capacitor. VC capacitor should be placed as close as possible to the VC pin to minimize potentially damaging voltage transients caused by trace inductance.

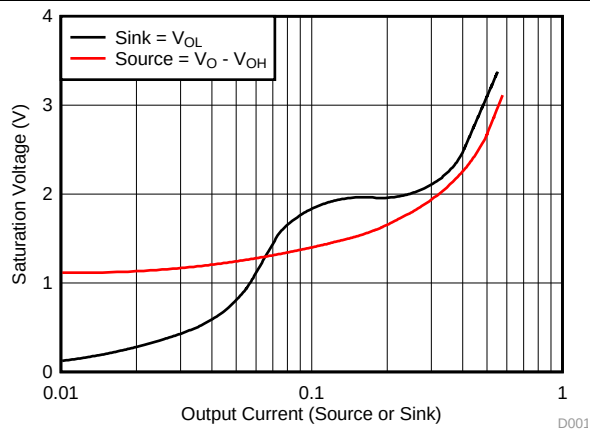
### 8.2.3.6 Output Capacitor Selection

The output capacitors smooth the output voltage ripple caused by inductor ripple current and provide a source of charge during load transient conditions.

### 8.2.3.7 Input Capacitor Selection

The input supply voltage typically has high source impedance at the switching frequency. Good quality input capacitors are necessary to limit the ripple voltage at the VIN pin while supplying most of the switch current during the on-time. The input capacitor should be selected for RMS current rating and minimum ripple voltage.

## 8.2.4 Application Curves



**Figure 13. UC1525A Output Saturation Characteristics**

## 9 Power Supply Recommendations

The voltage range for  $V_{IN}$  is 8 V to 35 V.

The voltage range for  $V_C$  is 4.5 V to 35 V. Choose a voltage level which is suitable for the power switch, for example, 12 V for MOSFET.

## 10 Layout

### 10.1 Layout Guidelines

High-speed circuits demand careful attention to layout and component placement. To assure proper performance of the UC1525A follow these rules:

- Use a ground plane
- Damp or clamp parasitic inductive kick energy from the gate of driven MOSFETs. Do not allow the output pins to ring below ground. A series gate resistor or a shunt 1-A Schottky diode at the output pin will serve this purpose.
- Bypass  $V_{IN}$ ,  $V_C$ , and  $V_{REF}$ . Use 0.1- $\mu$ F monolithic ceramic capacitors with low equivalent series inductance. Allow less than 1 cm of total lead length for each capacitor between the bypassed pin and the ground plane.
- Treat the timing capacitor,  $C_T$ , like a bypass capacitor.

### 10.2 Layout Example

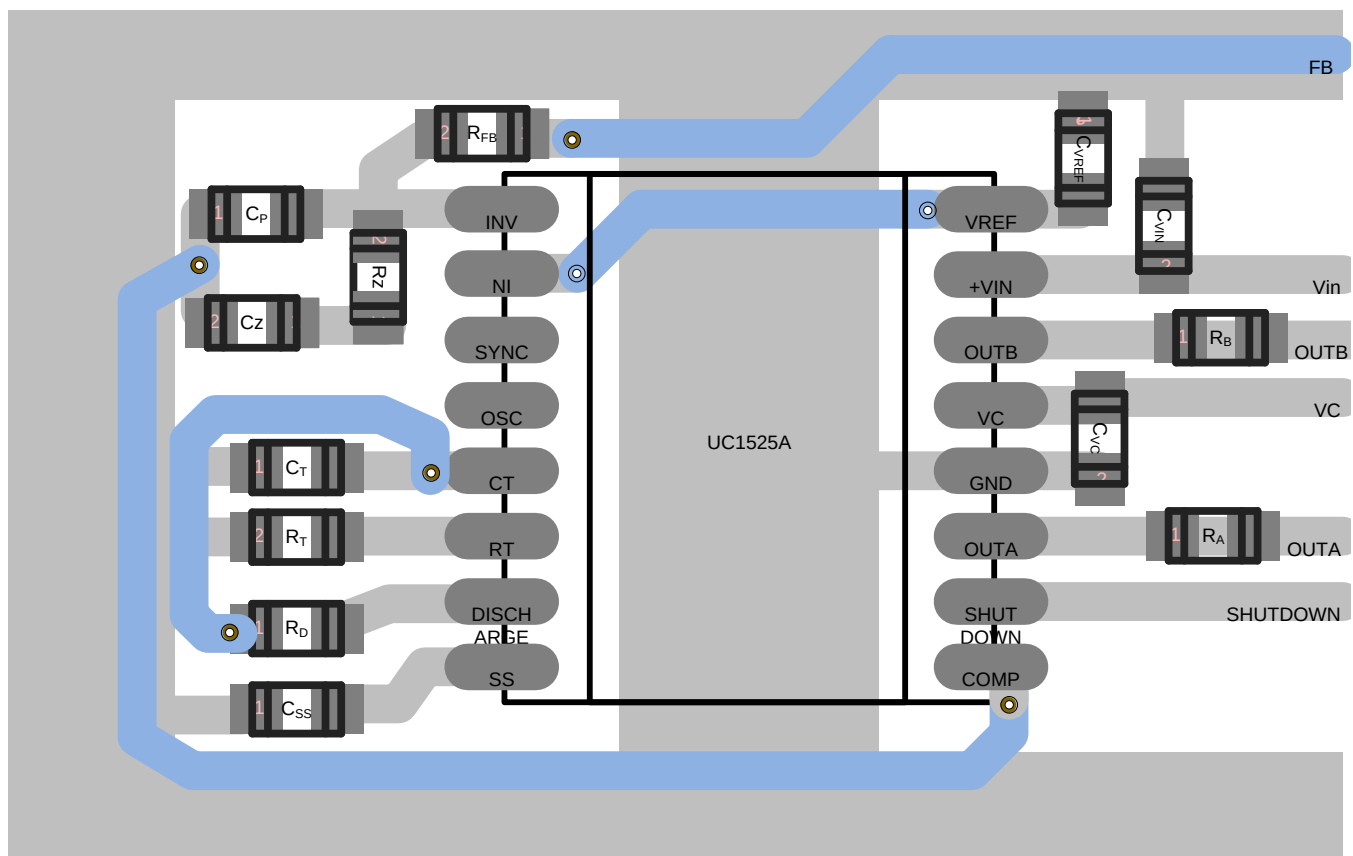


Figure 14. UC1525A Layout Example



## 11 Device and Documentation Support

### 11.1 Documentation Support

#### 11.1.1 Related Documentation

For related documentation see the following:

[Switching Power Supply Topology Voltage Mode vs Current Mode](#) (SLUA119)

### 11.2 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 2. Related Links**

| PARTS   | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|---------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| UC1525A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| UC1527A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| UC2525A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| UC2527A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| UC3525A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| UC3527A | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 11.3 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At [e2e.ti.com](http://e2e.ti.com), you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

### 11.4 Trademarks

E2E is a trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

### 11.5 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

### 11.6 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

**PACKAGING INFORMATION**

| Orderable part number          | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6)                     |
|--------------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|-----------------------------------------|
| <a href="#">5962-89511032A</a> | NRND          | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>89511032A<br>UC1525AL/<br>883B |
| <a href="#">5962-8951103EA</a> | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951103EA<br>UC1525AJ/883B         |
| <a href="#">5962-8951104EA</a> | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951104EA<br>UC1527AJ/883B         |
| <a href="#">UC1525AJ</a>       | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1525AJ                                |
| UC1525AJ.A                     | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1525AJ                                |
| <a href="#">UC1525AJ883B</a>   | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951103EA<br>UC1525AJ/883B         |
| UC1525AJ883B.A                 | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951103EA<br>UC1525AJ/883B         |
| <a href="#">UC1525AL</a>       | NRND          | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1525AL                                |
| UC1525AL.A                     | NRND          | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1525AL                                |
| <a href="#">UC1525AL883B</a>   | NRND          | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>89511032A<br>UC1525AL/<br>883B |
| UC1525AL883B.A                 | NRND          | Production           | LCCC (FK)   20 | 55   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-<br>89511032A<br>UC1525AL/<br>883B |
| <a href="#">UC1527AJ</a>       | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1527AJ                                |
| UC1527AJ.A                     | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | UC1527AJ                                |
| <a href="#">UC1527AJ883B</a>   | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951104EA<br>UC1527AJ/883B         |
| UC1527AJ883B.A                 | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -55 to 125   | 5962-8951104EA<br>UC1527AJ/883B         |
| <a href="#">UC2525ADW</a>      | Obsolete      | Production           | SOIC (DW)   16 | -                     | -           | Call TI                              | Call TI                           | -25 to 85    | UC2525ADW                               |
| <a href="#">UC2525ADWTR</a>    | NRND          | Production           | SOIC (DW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -25 to 85    | UC2525ADW                               |
| UC2525ADWTR.A                  | NRND          | Production           | SOIC (DW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -25 to 85    | UC2525ADW                               |

| Orderable part number       | Status<br>(1) | Material type<br>(2) | Package   Pins | Package qty   Carrier | RoHS<br>(3) | Lead finish/<br>Ball material<br>(4) | MSL rating/<br>Peak reflow<br>(5) | Op temp (°C) | Part marking<br>(6) |
|-----------------------------|---------------|----------------------|----------------|-----------------------|-------------|--------------------------------------|-----------------------------------|--------------|---------------------|
| <a href="#">UC2525AJ</a>    | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -25 to 85    | UC2525AJ            |
| UC2525AJ.A                  | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | -25 to 85    | UC2525AJ            |
| <a href="#">UC2525AN</a>    | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -25 to 85    | UC2525AN            |
| UC2525AN.A                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -25 to 85    | UC2525AN            |
| UC2525ANG4                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -25 to 85    | UC2525AN            |
| <a href="#">UC2525BDW</a>   | Active        | Production           | SOIC (DW)   16 | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -25 to 85    | UC2525BDW           |
| UC2525BDW.A                 | Active        | Production           | SOIC (DW)   16 | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | -25 to 85    | UC2525BDW           |
| <a href="#">UC2525BN</a>    | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -25 to 85    | UC2525BN            |
| UC2525BN.A                  | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -25 to 85    | UC2525BN            |
| <a href="#">UC2527AN</a>    | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | UC2527AN            |
| UC2527AN.A                  | Active        | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | -40 to 85    | UC2527AN            |
| <a href="#">UC3525ADW</a>   | NRND          | Production           | SOIC (DW)   16 | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| UC3525ADW.A                 | NRND          | Production           | SOIC (DW)   16 | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| UC3525ADWG4                 | NRND          | Production           | SOIC (DW)   16 | 40   TUBE             | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| <a href="#">UC3525ADWTR</a> | NRND          | Production           | SOIC (DW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| UC3525ADWTR.A               | NRND          | Production           | SOIC (DW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| UC3525ADWTRG4               | NRND          | Production           | SOIC (DW)   16 | 2000   LARGE T&R      | Yes         | NIPDAU                               | Level-2-260C-1 YEAR               | 0 to 70      | UC3525ADW           |
| <a href="#">UC3525AJ</a>    | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | 0 to 70      | UC3525AJ            |
| UC3525AJ.A                  | NRND          | Production           | CDIP (J)   16  | 25   TUBE             | No          | SNPB                                 | N/A for Pkg Type                  | 0 to 70      | UC3525AJ            |
| <a href="#">UC3525AN</a>    | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3525AN            |
| UC3525AN.A                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3525AN            |
| UC3525ANG4                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3525AN            |
| <a href="#">UC3527AN</a>    | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3527AN            |
| UC3527AN.A                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3527AN            |
| UC3527ANG4                  | NRND          | Production           | PDIP (N)   16  | 25   TUBE             | Yes         | NIPDAU                               | N/A for Pkg Type                  | 0 to 70      | UC3527AN            |

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

**Important Information and Disclaimer:** The information provided on this page represents TI's knowledge and belief as of the date that it is provided. TI bases its knowledge and belief on information provided by third parties, and makes no representation or warranty as to the accuracy of such information. Efforts are underway to better integrate information from third parties. TI has taken and continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

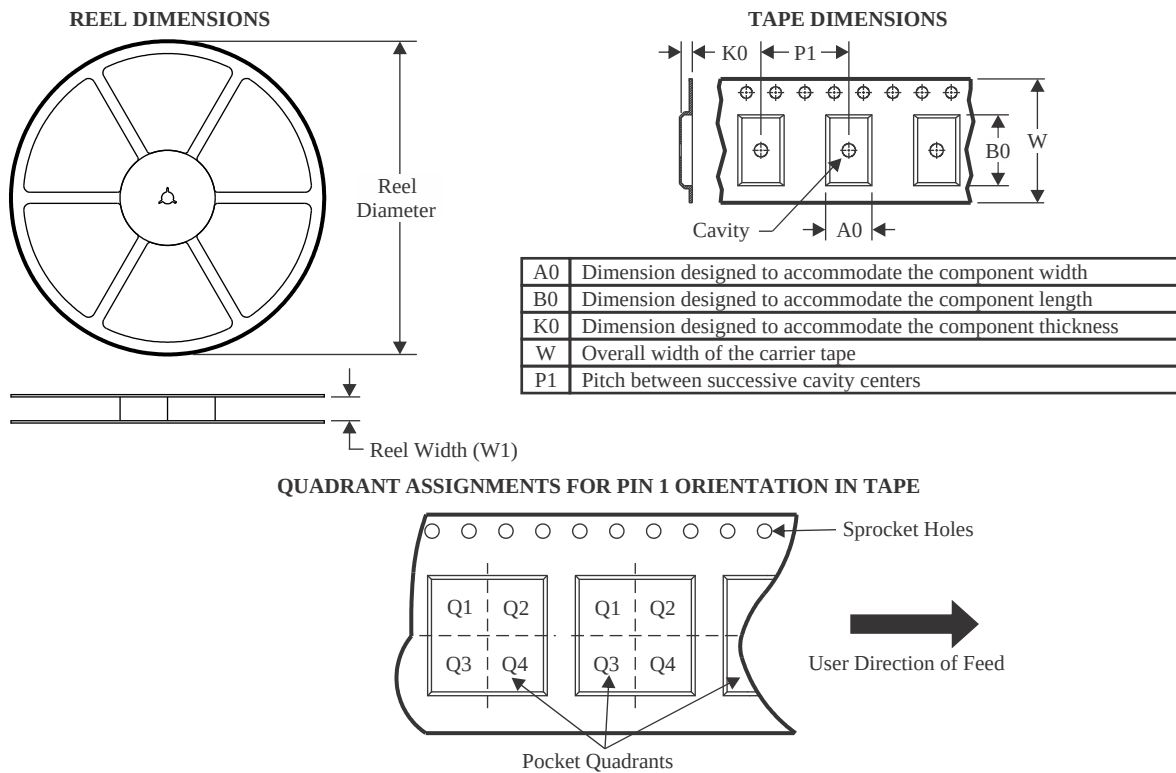
**OTHER QUALIFIED VERSIONS OF UC1525A, UC1527A, UC2525A, UC2525AM, UC3525A, UC3525AM, UC3527A :**

- Catalog : [UC3525A](#), [UC3527A](#), [UC2525A](#), [UC3525AM](#), [UC3525A](#)
- Military : [UC2525AM](#), [UC1525A](#), [UC1525A](#), [UC1527A](#)

NOTE: Qualified Version Definitions:

- Catalog - TI's standard catalog product
- Military - QML certified for Military and Defense Applications

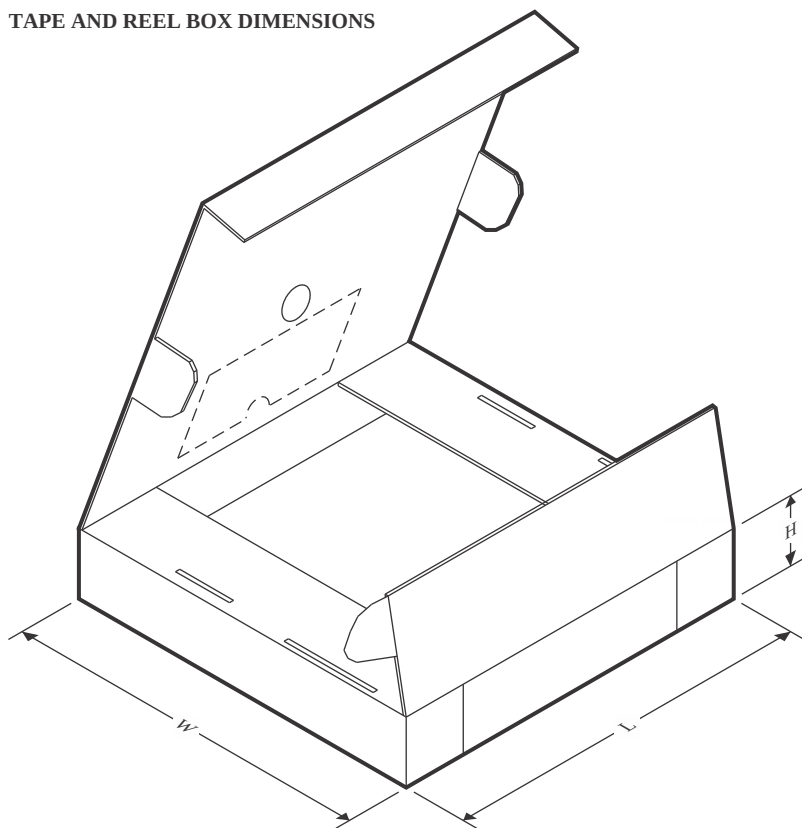
## TAPE AND REEL INFORMATION



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| UC2525ADWTR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |
| UC3525ADWTR | SOIC         | DW              | 16   | 2000 | 330.0              | 16.4               | 10.75   | 10.7    | 2.7     | 12.0    | 16.0   | Q1            |

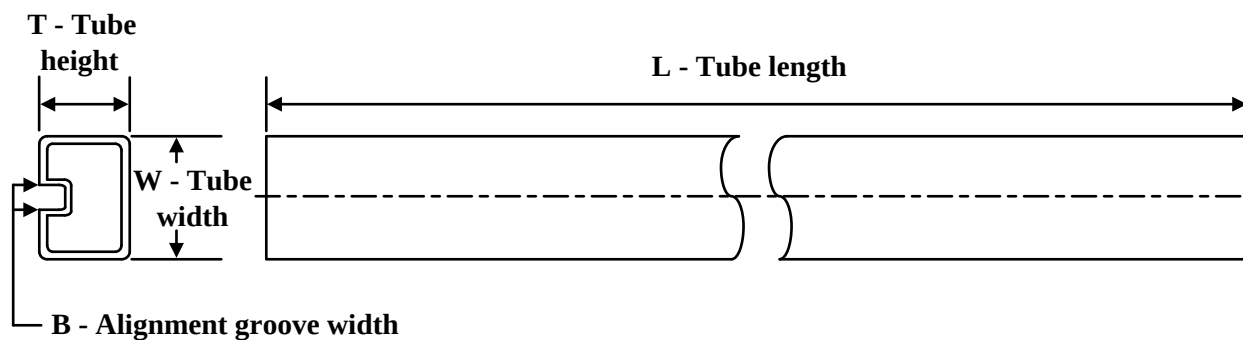
## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| UC2525ADWTR | SOIC         | DW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |
| UC3525ADWTR | SOIC         | DW              | 16   | 2000 | 353.0       | 353.0      | 32.0        |

## TUBE



\*All dimensions are nominal

| Device         | Package Name | Package Type | Pins | SPQ | L (mm) | W (mm) | T (μm) | B (mm) |
|----------------|--------------|--------------|------|-----|--------|--------|--------|--------|
| 5962-89511032A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| UC1525AL       | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| UC1525AL.A     | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| UC1525AL883B   | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| UC1525AL883B.A | FK           | LCCC         | 20   | 55  | 506.98 | 12.06  | 2030   | NA     |
| UC2525AN       | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2525AN.A     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2525ANG4     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2525BDW      | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC2525BDW.A    | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC2525BN       | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2525BN.A     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2527AN       | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC2527AN.A     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3525ADW      | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC3525ADW.A    | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC3525ADWG4    | DW           | SOIC         | 16   | 40  | 507    | 12.83  | 5080   | 6.6    |
| UC3525AN       | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3525AN.A     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3525ANG4     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3527AN       | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3527AN.A     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |
| UC3527ANG4     | N            | PDIP         | 16   | 25  | 506    | 13.97  | 11230  | 4.32   |

## GENERIC PACKAGE VIEW

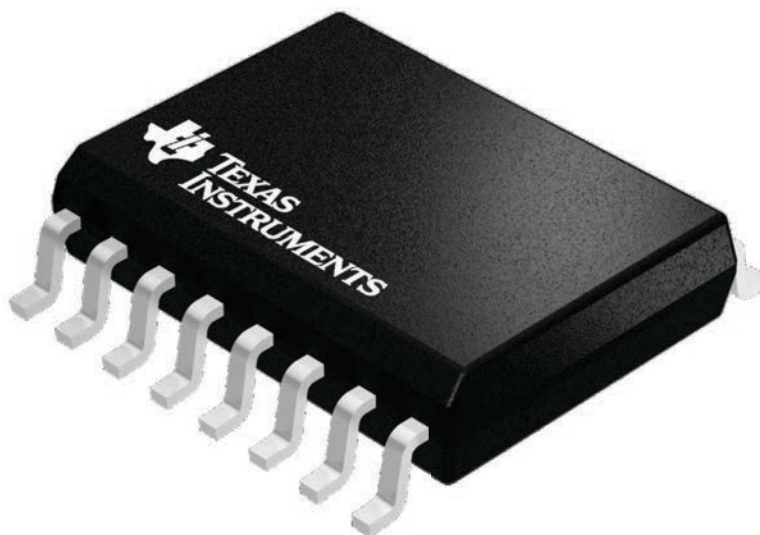
**DW 16**

**SOIC - 2.65 mm max height**

7.5 x 10.3, 1.27 mm pitch

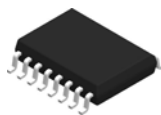
SMALL OUTLINE INTEGRATED CIRCUIT

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.



4224780/A



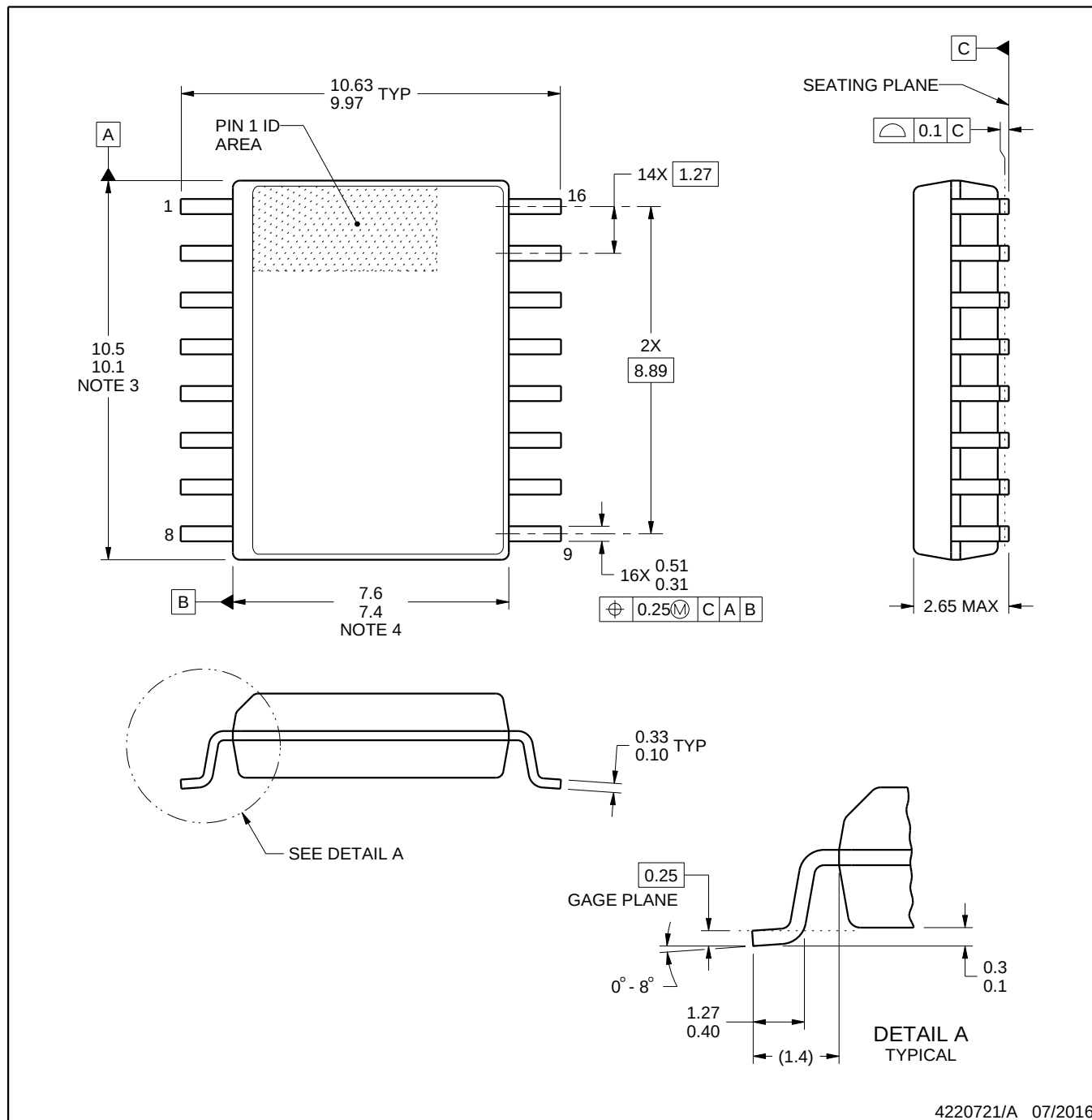


DW0016A

# PACKAGE OUTLINE

## SOIC - 2.65 mm max height

SOIC



4220721/A 07/2016

### NOTES:

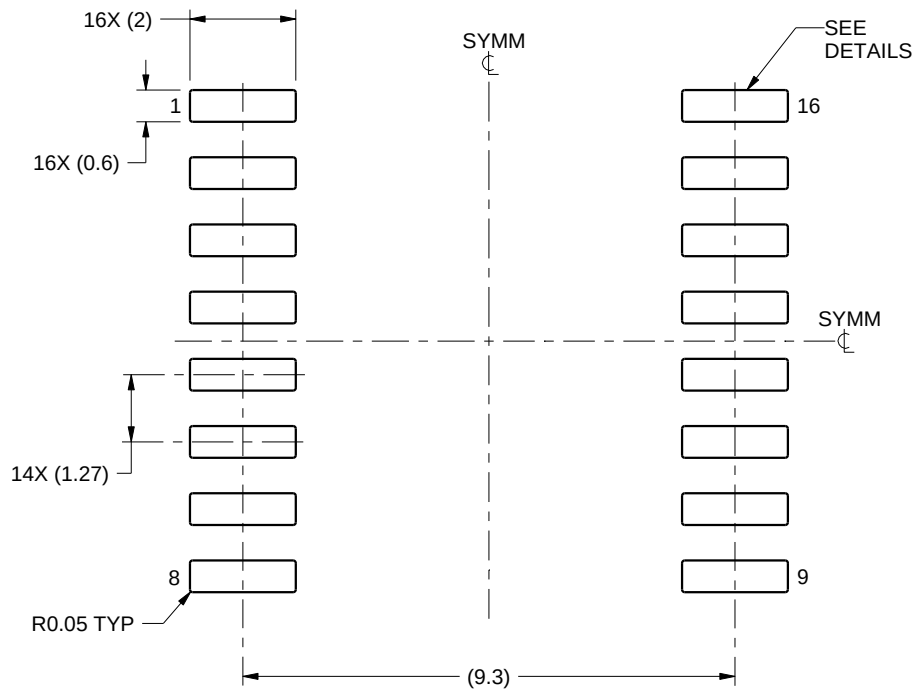
1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.
5. Reference JEDEC registration MS-013.

# EXAMPLE BOARD LAYOUT

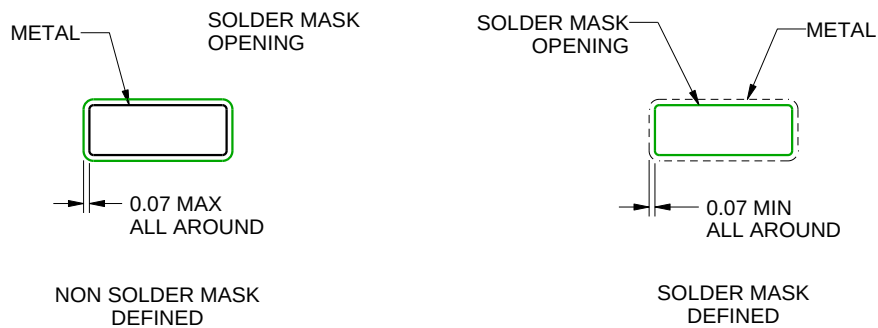
DW0016A

SOIC - 2.65 mm max height

SOIC



LAND PATTERN EXAMPLE  
SCALE:7X



SOLDER MASK DETAILS

4220721/A 07/2016

NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

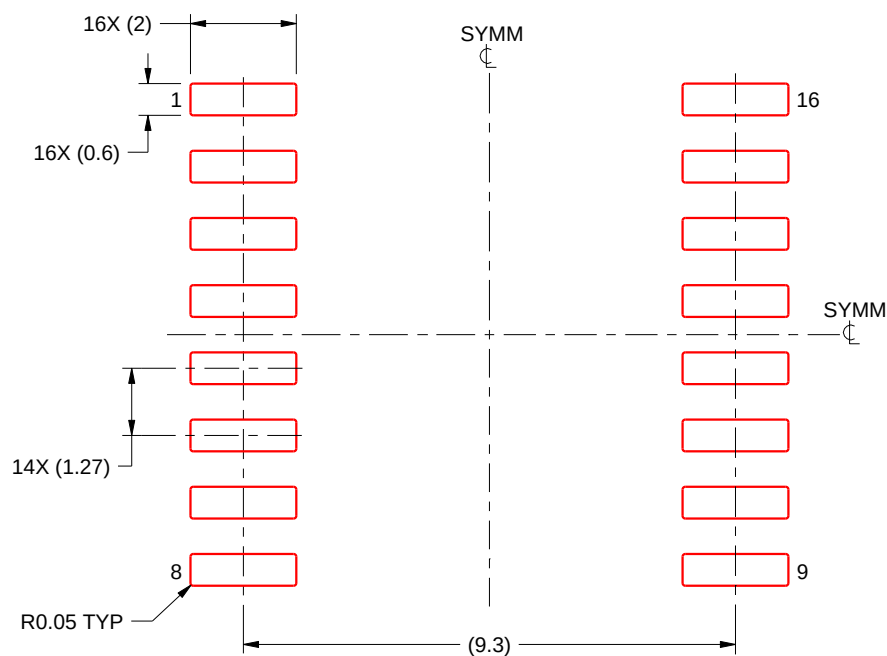
7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

# EXAMPLE STENCIL DESIGN

DW0016A

SOIC - 2.65 mm max height

SOIC



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL  
SCALE:7X

4220721/A 07/2016

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

## GENERIC PACKAGE VIEW

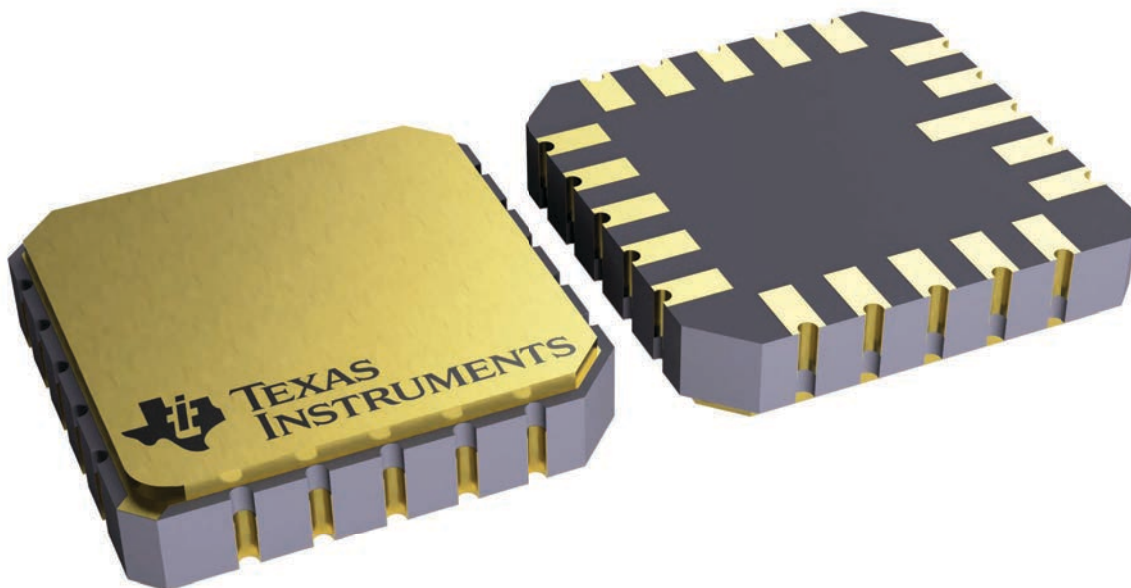
**FK 20**

**LCCC - 2.03 mm max height**

8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary.  
Refer to the product data sheet for package details.

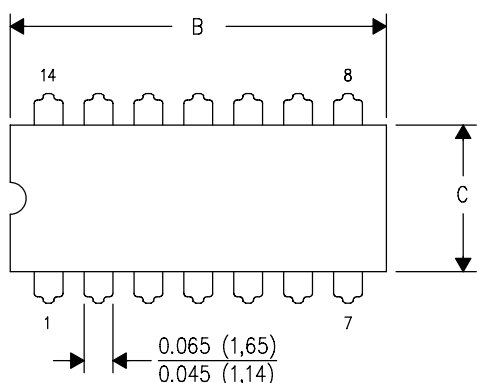


4229370VA\

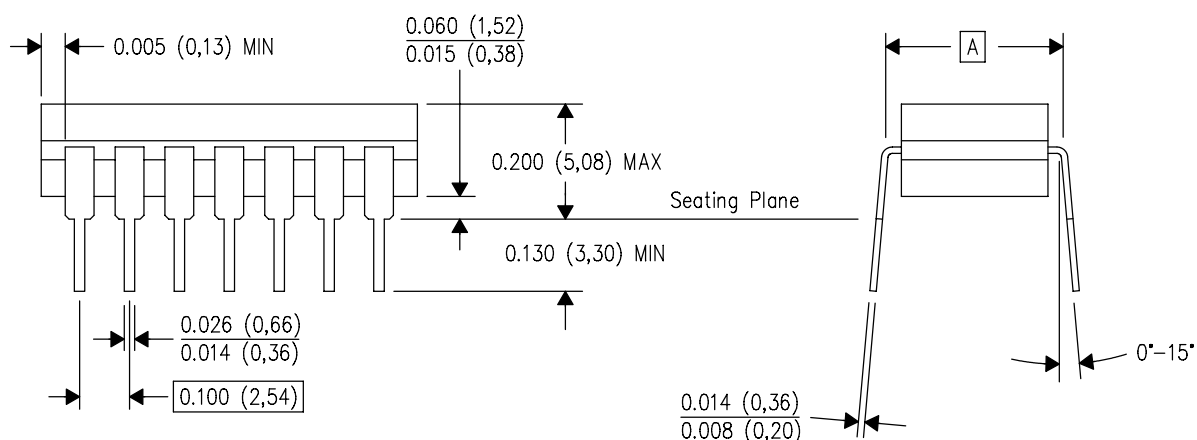
J (R-GDIP-T\*\*)

14 LEADS SHOWN

# CERAMIC DUAL IN-LINE PACKAGE



| PINS **<br>DIM | 14                     | 16                     | 18                     | 20                     |
|----------------|------------------------|------------------------|------------------------|------------------------|
| A              | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC | 0.300<br>(7,62)<br>BSC |
| B MAX          | 0.785<br>(19,94)       | .840<br>(21,34)        | 0.960<br>(24,38)       | 1.060<br>(26,92)       |
| B MIN          | —                      | —                      | —                      | —                      |
| C MAX          | 0.300<br>(7,62)        | 0.300<br>(7,62)        | 0.310<br>(7,87)        | 0.300<br>(7,62)        |
| C MIN          | 0.245<br>(6,22)        | 0.245<br>(6,22)        | 0.220<br>(5,59)        | 0.245<br>(6,22)        |



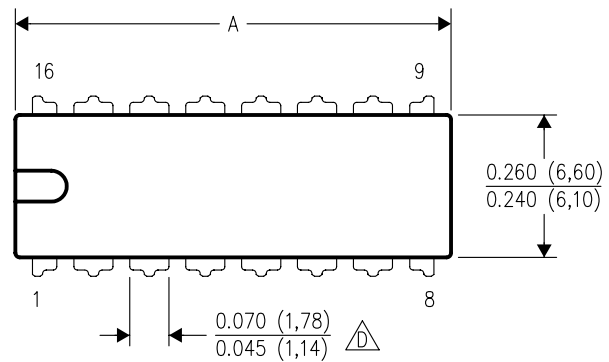
4040083/F 03/03

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. This package is hermetically sealed with a ceramic lid using glass frit.
  - D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
  - E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

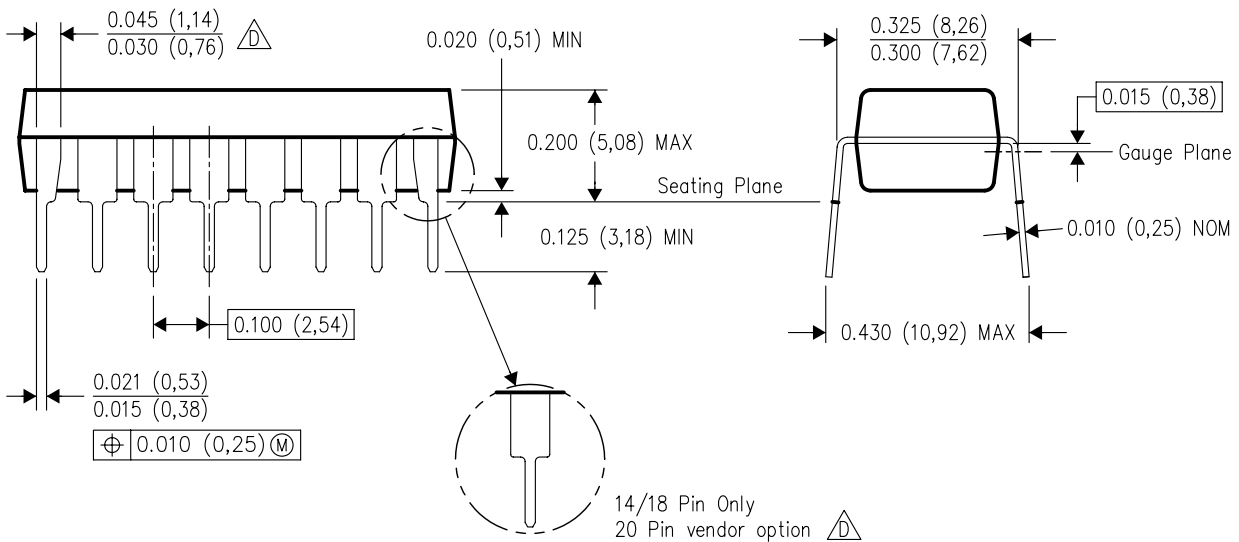
## N (R-PDIP-T\*\*)

16 PINS SHOWN

## PLASTIC DUAL-IN-LINE PACKAGE



| PINS **             | 14               | 16               | 18               | 20               |
|---------------------|------------------|------------------|------------------|------------------|
| DIM                 |                  |                  |                  |                  |
| A MAX               | 0.775<br>(19,69) | 0.775<br>(19,69) | 0.920<br>(23,37) | 1.060<br>(26,92) |
| A MIN               | 0.745<br>(18,92) | 0.745<br>(18,92) | 0.850<br>(21,59) | 0.940<br>(23,88) |
| MS-001<br>VARIATION | AA               | BB               | AC               | AD               |



14/18 Pin Only  
20 Pin vendor option

4040049/E 12/2002

- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
  - The 20 pin end lead shoulder width is a vendor option, either half or full width.

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